

C2225X125K2RACTU

Aliases (C2225X125K2RAC7800) SMD Comm X7R Flex, Ceramic, 1.2 uF, 10%, 200 VDC, X7R, SMD, MLCC, FT-CAP, Temperature Stable, 2225, 3.2 mm



Click here for the 3D model.

| General Information | |
|--------------------------|--|
| Series | SMD Comm X7R Flex |
| Style | SMD Chip |
| Description | SMD, MLCC, FT-CAP, Temperature Stable |
| Features | FT-CAP, Temperature Stable |
| RoHS | Yes |
| Termination | Flexible Termination |
| Marking | No |
| AEC-Q200 | No |
| Typical Component Weight | 350 mg |
| Shelf Life | 78 Weeks |
| MSL | 1 |

| | Specifications | |
|--|--|--|
| | Capacitance | 1.2 uF |
| | Measurement Condition | 1 kHz 1.0Vrms |
| | Tolerance | 10% |
| | Voltage DC | 200 VDC |
| | Dielectric Withstanding Voltage | 500 VDC |
| | Temperature Range | -55/+125°C |
| | Temp. Coefficient | X7R |
| | Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC) | 15%, 1kHz 1.0Vrms |
| | Dissipation Factor | 2.5%1kHz1.0Vrms |
| | Aging Rate | 3% Loss/Decade Hour: Referee Time is 1000 Hours |
| | Insulation Resistance | 833.3 MOhms |

 Dimensions

 Chip Size
 2225

 L
 5.9mm +/-0.75mm

 W
 6.4mm +/-0.4mm

 T
 1.4mm +/-0.15mm

 S
 3.2mm MIN

 B
 0.7mm +/-0.35mm

Packaging Specifications Packaging

| Packaging | T&R, 180mm, Plastic Tape |
|--------------------|--------------------------|
| Packaging Quantity | 1000 |

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